AMORPHOUS-SILICON MODULE HOT-SPOT TESTING

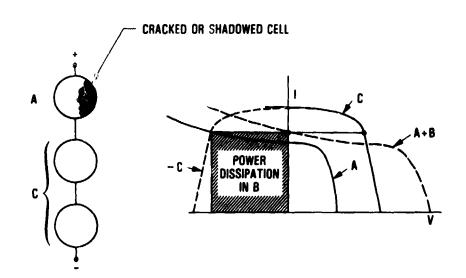
JET PROPULSION LABORATORY

C. C. Gonzalez

Background

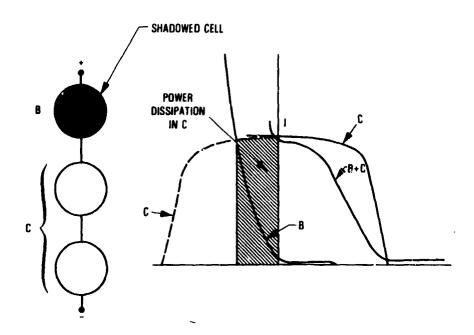
- Hot-spot heating occurs when ceil short-circuit current is lower than string operating current
 - Cell goes into reverse bias and absorbs power
 (= reverse-bias voltage x cell current)
 - Reverse-bias voltage is proportional to the number of cells in series with the affected cell
 - It is necessary to limit reverse-bias voltage by means of bypass diodes
- Nonuniform heating over cell area leads to increased temperature for same power dissipation

Visualization of Hot-Spot Cell Heating with High-Shunt Resistance Cell





Visualization of Hot-Spot Cell Heating with Low-Shunt Resistance Cell



Key Lessons from Crystalline Silicon

- Maximum allowable temperature for encapsulants: 120°C to 140°C
- Temperature very dependent on cell-to-cell shunt-resistance differences
- Lateral heat transfer from hot spot is important
- · Common failure at high heat levels is cell shorting
- Typical crystalline-silicon module requires bypass diades around every 12 to 18 cells
- Heating is highly non-linear function of applied current and voltage
 - Non-linear reverse I-V characteristic
 - Changing shunt-resistance with temperature
 - · Changing hot-spot area with temperature

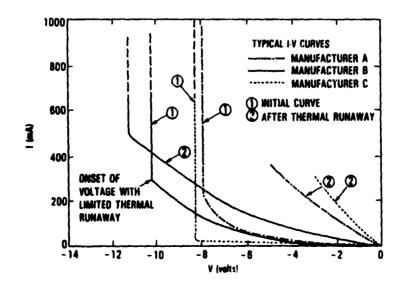
Amorphous-Cell Hot-Spot Testing Objectives

- To develop the techniques required for performing reverse-bias testing of amorphous cells
- To quantify the response of amorphous cells to reverse biasing
- To develop guidelines for reducing hot-spot susceptibility of amorphous modules
- To develop a qualification test for hot-spot testing of amorphous modules

Approach

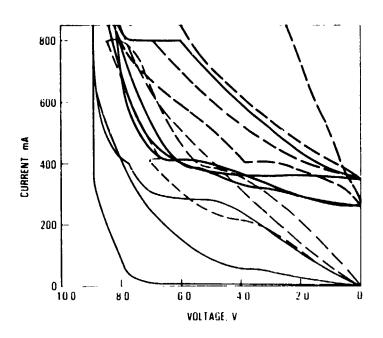
- Amorphous cells tested using two techniques
 - · First is equivalent to that used in hot-spot testing of crystalline cells
 - Hot-spot temperature monitored using IR camera
 - Reverse-bias I-V curve plotted as test is conducted
 - Second consists of pulsed reverse-bias voltage ranging in duration from 0.01 to 100 milliseconds
 - I-V curve plotted after each pulse

Amorphous-Cell Second-Quadrant I-V Curves

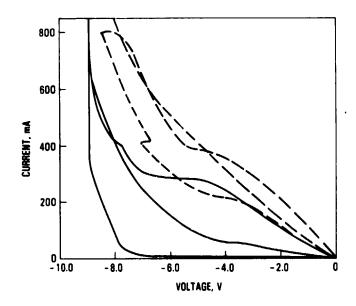




Amorphous-Module Cell-Reverse Quadrant I-V Curves Illuminated Cells



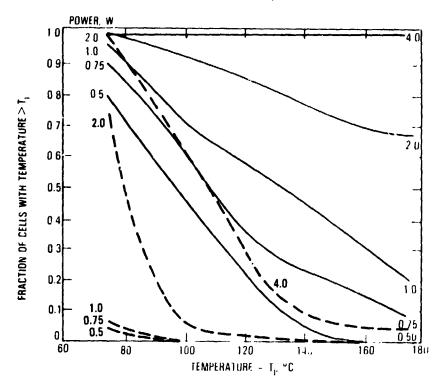
Amorphous-Module Cell-Reverse Quadrant I-V Curves Unilluminated Cells



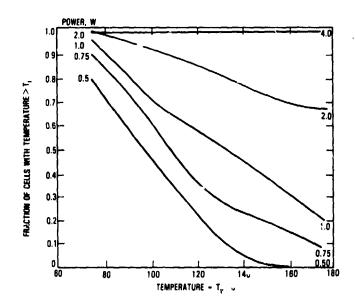
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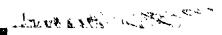
MODULE DEVELOPMENT AND ENGINEERING SCIENCES

Fraction of Cells Reaching a Given Temperature as a Function of Power Dissipated (Modules)



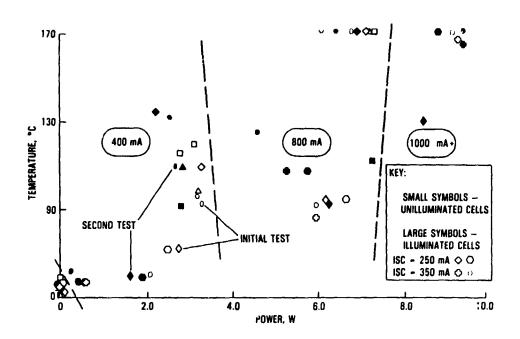
Fraction of Cells Reaching a Given Temperature as a Function of Power Dissipated (Submodules)



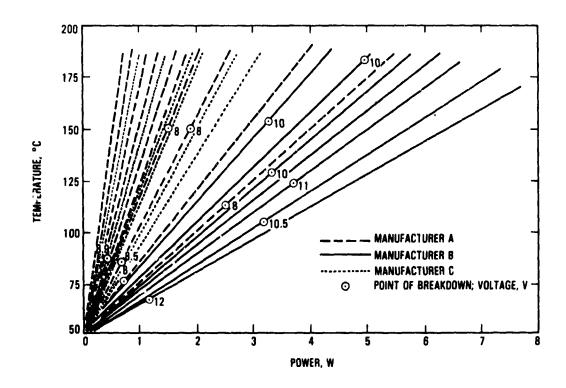




Hot-Spot Temperature Versus Power for Cells in Encapsulated Module (Test Current Equal to 1, 2, and 2 + Cell I_{SC})



Hot-Spot Temperature Versus Power (Unencapsulated Amorphous-Silicon Submodules, No Illumination)





Hot-Spot Qualification Test

- Hot-spot qualification test performed on one module type
- Same procedure and equipment as for crystalline cells
 - 100-hour cyclic test
 - Treated as low-shunt-resistance cell (Type B)
 - Test performed in absence of illumination
 - Test current is module short-circuit current
 - Module temperature raised to field environment (45°C to 50°C)

Results and Conclusions

- Amorphous cells undergo hot-spot heating similarly to crystalline cells
 - Shunt resistance levels similar
 - Tolerance to heating level similar
- Comparison of results obtained with submodules versus actual module indicate heating level lower in latter
 - Module structure contains thick (relative to front surface) glass substrate not present in submodules
- Module design must address hot-spot heating
 - Heat-sinking cells
 - Use of bypass diodes
 - Use of smaller solar cells (lower maximum current)
- Hot-spot qualification test conducted on module
 - Module passed test with no instabilities
 - Minor cell erosion occurred that is characteristic of amorphous cells

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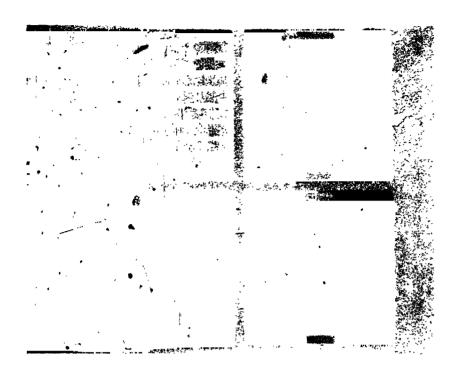
Hot-Spot Test Set-Up



Test Set-Up for Submodule Using Conductive Elastomeric Material



Results of Hot-Spot Testing of Four Submodules



Close-up View of Hot-Spot Area



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Front Side of Arco Test Module



Back Side of Arco Test Module Showing Added Conductive Ribbon Attached with Conductive Epoxy

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MODULE DEVELOPMENT AND ENGINEERING SCIENCES

Close-up of Arco Test Module Showing Results of Hot-Spot Testing

Hot-Spot Recorded on IR Monitor Using Time-Lapse Photography

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MODULE DEVELOPMENT AND ENGINEERING SCIENCES

Ocilloscope Trace of Pulse-Reverse Bias Testing

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